TEXAS INSTRUMENTS

Bill of Materials

TI DESIGNS

TIDA-00557

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	PCB Footprint	Note
1	1	!PCB1		Printed Circuit Board	Any	TIDA-00557		
2	28	C1, C2, C3, C4, C5, C6, C7, C8, C9, C10, C11, C12, C13, C14, C15, C16, C17, C18, C19, C20, C21, C22, C24, C26, C30, C31, C33, C36	0.1uF	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	Kemet	C0603C104K5RACTU	603	
3	2	C23, C29	10uF	CAP, CERM, 10uF, 35V, +/-20%, X7R, 1210	Taiyo Yuden	GMK325AB7106MM-T	1210	
4	4	C25, C28, C32, C34	1uF	CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603	TDK	C1608X7R1C105K	603	
5	2	C27, C35	4.7uF	CAP, TA, 4.7uF, 35V, +/-10%, 1.9 ohm, SMD	Vishay-Sprague	293D475X9035C2TE3	6032-28	
6	2	C37, C38	1000pF	CAP, CERM, 1000pF, 2KV 10% X7R 1206	Johanson Dielectrics Inc	202R18W102KV4E	1206	
7	3	D1, D2, D3	20V	Diode, Schottky, 20V, 0.5A, SOD-123	Diodes Inc	B0520LW-7-F	SOD-123	
8	1	D4	Green	LED SmartLED Green 570NM	OSRAM	LG L29K-G2J1-24-Z	LED0603AA	
9	2	D5, D23	3.9V	DIODE ZENER 3.9V 500MW SOD123	Diodes Incorporated	MMSZ5228B-7-F	sod-123	
10	1	D6	SMBJ18CA	TVS 18 VOLT 600 WATT BI-DIR SMB	Littelfuse Inc	SMBJ18CA	DIO_SMB_BIAAAA	
11	16	D7, D8, D9, D10, D11, D12, D13, D14, D15, D16, D17, D18, D19, D20, D21, D22	19	Diode, TVS, ARRAY, 19V, SOD323	Bourns Inc.	CDSOD323-T12C	sod-323	
12	2	FB1, FB2	1000 OHM	FERRITE CHIP 1000 OHM 300MA 0603	TDK Corporation	MMZ1608B102C	603	
13	5	H1, H2, H3, H4, H9		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	B&F Fastener Supply	NY PMS 440 0025 PH	NY PMS 440 0025 PH	
14	5	H5, H6, H7, H8, H10		Standoff, Hex, 0.5L #4-40 Nylon"	Keystone	1902C	Keystone_1902C	
15	1	J1	747250-4	Connector, 9-pin D, Right Angle, Male	AMP	747250-4	DB9_RA	
16	2	J2, J4		Terminal Block, 8x1, 2.54 mm, TH	Phoenix Contact	1725711	CONN_1725711	
17	1	J3		CONN DB9 FEMALE R/A SOLDER TH	NorComp	182-009-213R171	NORCOMP_182-009-213R171	
18	2	J5, J6		CONN TERM BLOCK 2.54MM 2POS PCB	On Shore Technology Inc	OSTVN02A150	CN2_MTB_P100_PD80_D1.1_S5.54X6.5_STACK	
19	2	L1, L2	120 ohm	Ferrite Bead, 120 ohm @ 100 MHz, 0.8 A, 0805	MuRata	BLM21AG121SN1D	0805_HV	
20	THT-14-423-10	000 per roll"	2065596	Thermal Transfer Printable Labels, 0.650 W x 0.200" H - 10	Brady	Label_650x200	LBL1	
21	8	R1, R2, R7, R8, R9, R10, R15, R16	10.0k	RES, 10.0k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW060310K0FKEA	603	
22	3	R17, R50, R51	0	RES, 0 ohm, 5%, 0.1W, 0603, RES, 0, 5%, 0.1 W, 0603, RES, 0, 5%, 0.1 W, 0603	Vishay-Dale	CRCW06030000Z0EA	603	
23	1	R18	300	RES, 300 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW0603300RJNEA	603	
24	16	R36	10	RES SMD 22 OHM 5% 1.5W 2512	Vishay-Dale	RPC2512JT22R0	2512	
25	2	R37, R38	0	RES, 0, 5%, 0.125 W, 0805	Vishay-Dale	CRCW08050000Z0EA	0805_HV	
26	1	T1	475uH	Transformer 475uH SMD	Wurth Electronics Midcom	760390014	760390015	
27	7	TP1, TP2, TP3, TP4, TP5, TP6, TP7	STD	Test Point, O.040 Hole	STD	STD	TP-040_RND	
28	2	U5, U7		IC, ISOLATOR DGTL 2CH 1/1, SOIC-8, ROHS	TEXAS INSTRUMENTS	ISO7321CD		
29	1	U6		3-V to 5.5-V Multichannel RS-232 Line Driver / Receiver with ±15-kV IEC ESD Protection, -40 to 85 degC, 28-Pin SOIC (DW), Green (RoHS & no Sb/Br)	Texas Instruments	TRS3243EIDWR	DW0028A_N	
30	1	U8		Robust EMC, Low Power, Quad-Channel Digital Isolators, DW0016B	Texas Instruments	ISO7341CDWR	DW0016B_HV	
31	2	U17, U19	TPS7A6533QKVURQ1	IC, 300-mA 40-V LOW-DROPOUT REGULATOR WITH 25-uA QUIESCENT CURRENT	TI	TPS7A6533QKVURQ1	KVU_1	
32	1	U18		Transformer Driver for Isolated Power Supplies, DBV0005A	Texas Instruments	SN6501DBV	DBV0005A_N	
33	0	FID1, FID2, FID3		Fiducial mark. There is nothing to buy or mount.	N/A	N/A	Fiducial10-20	
34	0	R27, R30	10	DNP	Vishay-Dale	DNP	2512	
35	0	R52, R53, R54, R55	10.0k	RES, 10.0k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW060310K0FKEA	603	
36	0	U13, U15		IC, ISOLATOR DGTL 2CH 1/1, SOIC-8, ROHS	TEXAS INSTRUMENTS	ISO7321CD		
37	0	U14		3-V to 5.5-V Multichannel RS-232 Line Driver / Receiver with ±15-kV ESD (HBM) Protection, -40 to 85 degC, 28-Pin SOIC (DW), Green (RoHS & no Sb/Br)	Texas Instruments	TRSF3238EIDWR	DW0028A_N	
38	0	U16		Robust EMC, Low Power, Quad-Channel Digital Isolators, DW0016B	Texas Instruments	ISO7341CDWR	DW0016B_HV	

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